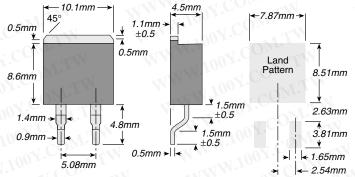
TDH Series

35 Watt DPAK Package Thick Film Power Surface Mount



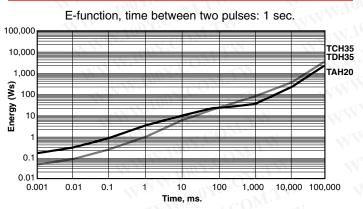
mounting applications; 35W power rating at 25°C case temperature.

DPAK style power package for surface Soldering note: During surface mount soldering the soldering temperature profile must not cause the metal tab of this device to exceed 220°C (260°C for the TDH35H)!

TEST DATA

Load Life	(MIL-R-39009, 2,000 hours	ΔR ±(1.0% +0.01Ω)	
Moisture Resistance	(MIL-Std-202, Method 106)	$\Delta R = (0.5\% + 0.01\Omega)$ max.	
Short Time Overload	(2 times rated power with applied voltage not to exceed 1.5 times maximum continuous operating voltage for 5 seconds)	ΔR ±(0.3% + 0.01Ω) max.	
Thermal Shock	(MIL–Std–202, Method 107, Cond. F)	$\Delta R = (0.3\% + 0.01\Omega)$ max.	
Terminal Strength	(MIL–Std–202, Method 211, Cond. A (Pull Test) 2.4N)	$\Delta R = (0.2\% + 0.01\Omega)$ max.	
Vibration, High Frequency	(MIL-STD-202, method 211, cond. A (pull test) 2.4N)	$\Delta R = (0.2\% + 0.01\Omega)$ max.	

PULSE-FORM



STANDARD PART NUMBERS FOR TDH SERIES

Ohms	Part Number 5% Tolerance	Ohms	Part Number 5% Tolerance
0.10	TDH35PR100JE	25	TDH35P25R0JE
0.15	TDH35PR150JE	33	TDH35P33R0JE
0.20	TDH35PR200JE	39	TDH35P39R0JE
0.25	TDH35PR250JE		TDH35P47R0JE
0.30	TDH35PR300JE		TDH35P68R0JE
0.36	TDH35PR360JE	75	TDH35P75R0JE
0.47	TDH35PR470JE	100	TDH35P100RJE
0.50	TDH35PR500JE	150	TDH35P150RJE
0.75	TDH35PR750JE		TDH35P200RJE
1.0	TDH35P1R00JE		TDH35P250RJE
2.0	TDH35P2R00JE	300	TDH35P300RJE
3.0	TDH35P3R00JE	500	TDH35P500RJE
5.0	TDH35P5R00JE	750	TDH35P750RJE
7.5	TDH35P7R50JE		TDH35P1K00JE
10	TDH35P10R0JE		TDH35P1K50JE
15 20	TDH35P15R0JE TDH35P20R0JE	2500 3000 5000	TDH35P2K50JE TDH35P3K00JE TDH35P5K00JE
			WW.1001.

Ohmite's TDH resistor is an economical solution to intermediate power application design requirements. TDH's reliable thick film on alumina substrate construction can be easily heat sinked for higher power performance. TDH resistors are ideal for pulseloading, pre-charge, bleeder, and snubber applications.

min.

curve.

process.

FEATURES

- 35 Watt power rating at 25°C
- · SMD DPAK package configuration
- · Heat resistance to cooling plate: Rth <4.28°C/W
- · A molded case for environmental protection.
- · Resistor element is electrically insulated from the metal sink tab.

SPECIFICATIONS

Material

Terminal: Copper

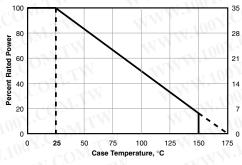
Terminal Plating: Lead Free Solder (97% Tin, 3% Silver)

Electrical

Resistance Range: 0.1Ω to $10K\Omega$ other values on request Tolerance: ±1% to ±10% (0.5% on request)

Max. Operating Voltage: 350V

DERATING



TAPE DIMENSIONS

10 seconds during soldering Derating: 100% @ 25°C to 0% @ 150°C curve referenced to case temperature Dielectric Strength: 1,800VAC

Operating Temperature Range: -55°C to +150°C

Insulation Resistance: 10GΩ

Power Rating: Depends upon

Working Temperature Range:

Solder Process: The TDH35P

cannot exceed 220°C (260°C

for the TDH35H) for more than

-55°C to +175°C

case temperature. See derating

Temperature Coefficient: 10Ω and above, ±50ppm/°C, referenced to 25°C, AR taken at +105°C. Between 1Ω and 10Ω . ±(100ppm+0.002Ω)/°C, referenced to 25°C, AR taken at +105°C.

Inductance: less than 20 nanohenries

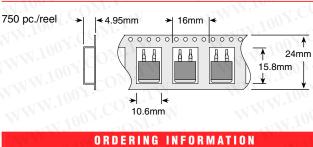
Flatness: less than 0.1mm tolerance

≥

Powel

Rated

Derating (thermal resistance): 0.23W/°C (4.28°C/W). The case temperature is to be used for purposes of establishing the applied power limit. The case temperature measurement must be made with a thermocouple contacting the center of the component mounted on the designed heat sink. Thermal grease should be applied propperly.



TDH35P R100 JE Tolerance Tolerance Tolerance Non-compliant style Package Modifier P = low temp. H = high temp. Package Modifier P = low temp. H = high temp. Tolerance Folds Compliant Non-compliant F = 10% NOn-compliant F = 10% Non-compliant Non-compliant Version unavailable Those = 10,000 Tolerance Folds Compliant Non-compliant Check product availability at www.ohmite.com Compliant Version unavailable							

